

A	B	C	D		E																																				
1			REV.	DESCRIPTION	ECN NO.	NAME	DATE																																		
1							<div style="border: 1px solid black; padding: 2px;">PRELIMINARY DESIGN IS SUBJECT TO CHANGE WITHOUT PRIOR NOTICE</div>																																		
2							NOTES: 1. Working temp: -25°C ~ 85°C. 2. Voltage rating: 125V AC/DC(rms) 3. Contact resistance: 55mΩ max. 4. Insulation resistance: 100MΩ min. 5. Current rating: 1A AV/DC 6. Withstanding Voltage: 500V AC/minute 7. Pin Retention Force: 5N min. 8. Housing material: LCP UL94-V0, Natural 9. Terminal materl: Brass, plating Ni 40μ" min , plating Tin 100μ"min. 10. Solder tab material: Brass, plating Ni 40μ" min , plating Tin 100μ"min.																																		
3			SECTION A-A																																						
4			2 PIN	3 PIN																																					
5			LOCK CONFIGURATION (锁扣位置)																																						
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